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November 2013

FQP20N06 — N-Channel QFET[®] MOSFET

FQP20N06

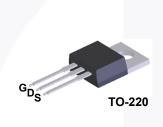
N-Channel QFET[®] MOSFET 60 V, 20 A, 60 m Ω

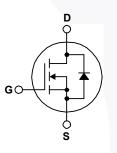
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 20 A, 60 V, $R_{DS(on)}$ = 60 m Ω (Max.) @ V_{GS} = 10 V, I_D = 10 A
- Low Gate Charge (Typ. 11.5 nC)
- Low Crss (Typ. 25 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

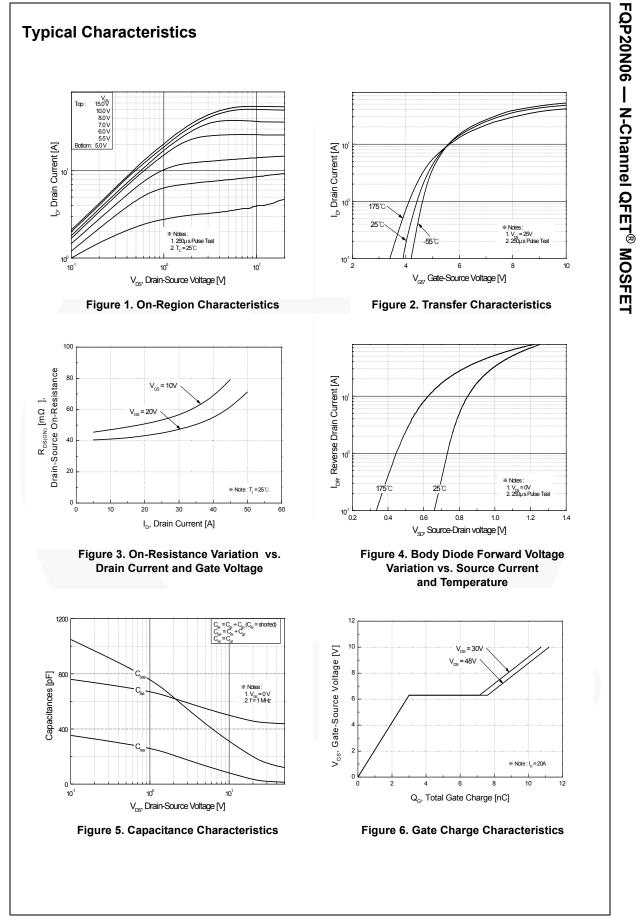
Symbol	Parameter		FQP20N06	Unit
V _{DSS}	Drain-Source Voltage		60	V
I _D	Drain Current - Continuous ($T_C = 25^\circ$	C)	20	A
	- Continuous (T _C = 100	°C)	14.1	A
I _{DM}	Drain Current - Pulsed	(Note 1)	80	Α
V _{GSS}	Gate-Source Voltage		± 25	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	155	mJ
I _{AR}	Avalanche Current	(Note 1)	20	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	5.3	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	7.0	V/ns
P _D	Power Dissipation ($T_C = 25^{\circ}C$)		53	W
	- Derate above 25°C		0.35	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temperature for Solderin 1/8" from Case for 5 seconds	ıg,	300	°C

Thermal Characteristics

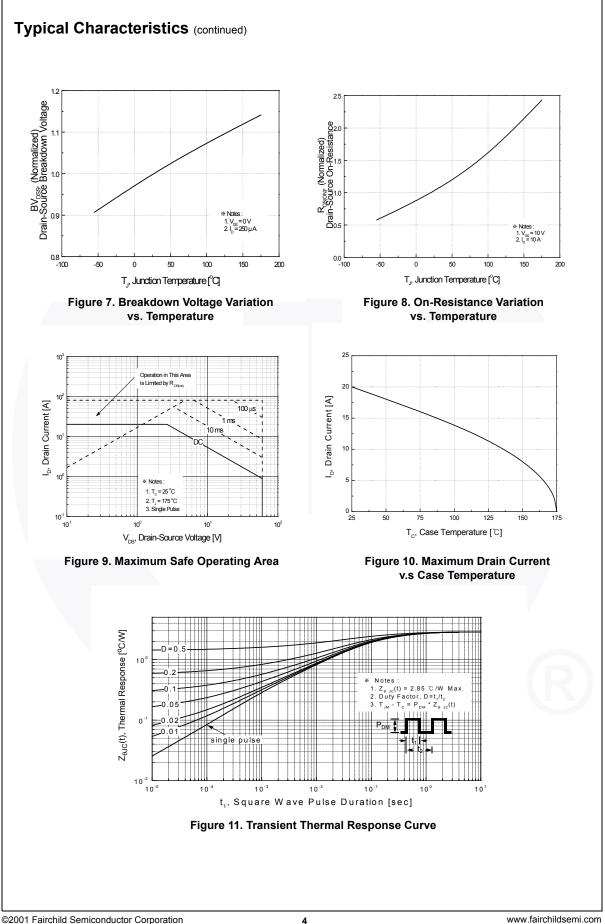
Symbol	Parameter	Parameter FQP20N06	
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	2.85	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

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Part Number Top Mark Package		Package	e Packing Method Reel Siz		Tape Width		h Q	Quantity	
FQP20	N06	FQP20N06	TO-220	Tube	N/A		N/A	5	0 units
ectri	cal Ch	naracteristics	T _C = 25°C	unless otherwise noted.					
Symbol		Parameter		Test Condit	ions	Min	Тур	Мах	Unit
Off Cha									
BV _{DSS}	Drain-Source Breakdown Voltage		V _{GS} = 0 V, I _D = 250 μA		60			V	
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient		ature	I_D = 250 µA, Referenced to 25°C			0.07		V/°C
DSS	Zero G	ate Voltage Drain Cu	irrent	$V_{\rm DS}$ = 60 V, $V_{\rm GS}$ = 0				1	μA
	2010 0		incin	V _{DS} = 48 V, T _C = 150°C				10	μA
I _{GSSF}	Gate-B	ody Leakage Curren	t, Forward	V_{GS} = 25 V, V_{DS} = 0				100	nA
GSSR	Gate-B	ody Leakage Curren	it, Reverse	V_{GS} = -25 V, V_{DS} = 0	V			-100	nA
On Cha	racter	istics							
V _{GS(th)}	Gate T	hreshold Voltage		$V_{DS} = V_{GS}, I_D = 250$	μA	2.0		4.0	V
R _{DS(on)}		Drain-Source sistance		V_{GS} = 10 V, I _D = 10 A			0.048	0.06	Ω
9 _{FS}	Forward Transconductance			V _{DS} = 25 V, I _D = 10 A			12		S
C _{iss} C _{oss} C _{rss}	Output	apacitance Capacitance e Transfer Capacitar	псе	V _{DS} = 25 V, V _{GS} = 0 f = 1.0 MHz	V,		450 170 25	590 220 35	pF pF
		aracteristics							P.
t _{d(on)}		n Delay Time					5	20	ns
t _r		n Rise Time		$V_{DD} = 30 V, I_D = 10 A,$ R _G = 25 Ω			45	100	ns
t _{d(off)}		ff Delay Time					20	50	ns
tf	Turn-O	ff Fall Time			(Note 4)		25	60	ns
Q _g	Total G	ate Charge		V _{DS} = 48 V, I _D = 20 A	4		11.5	15	nC
Q _{gs}	Gate-S	ource Charge		$V_{GS} = 10 V$.,		3		nC
Q _{gd}	Gate-D	rain Charge		66	(Note 4)		4.5		nC
	ource	Diode Characte	eristics an	d Maximum Rati	nas		<u> </u>		L
s	r	um Continuous Drair			J -			20	Α
s _м		um Pulsed Drain-Sou						80	Α
V _{SD}	Drain-S	Source Diode Forwar	d Voltage	V _{GS} = 0 V, I _S = 20 A				1.5	V
t _{rr}	Revers	e Recovery Time	-	V _{GS} = 0 V, I _S = 20 A,			43		ns
Q _{rr}	Revers	e Recovery Charge		dI _F / dt = 100 A/µs			50		nC
$\begin{array}{l} L=450 \; \mu H, \\ I_{SD} \leq 20 \; A, \end{array}$	$I_{AS} = 20 \text{ A},$ di/dt ≤ 300	e width limited by maximum V _{DD} = 25 V, R _G = 25 Ω , sta) A/µs, V _{DD} \leq BV _{DSS} , starti c of Operating Temperature	inting $T_J = 25^{\circ}C$. ng $T_J = 25^{\circ}C$.	ature.					

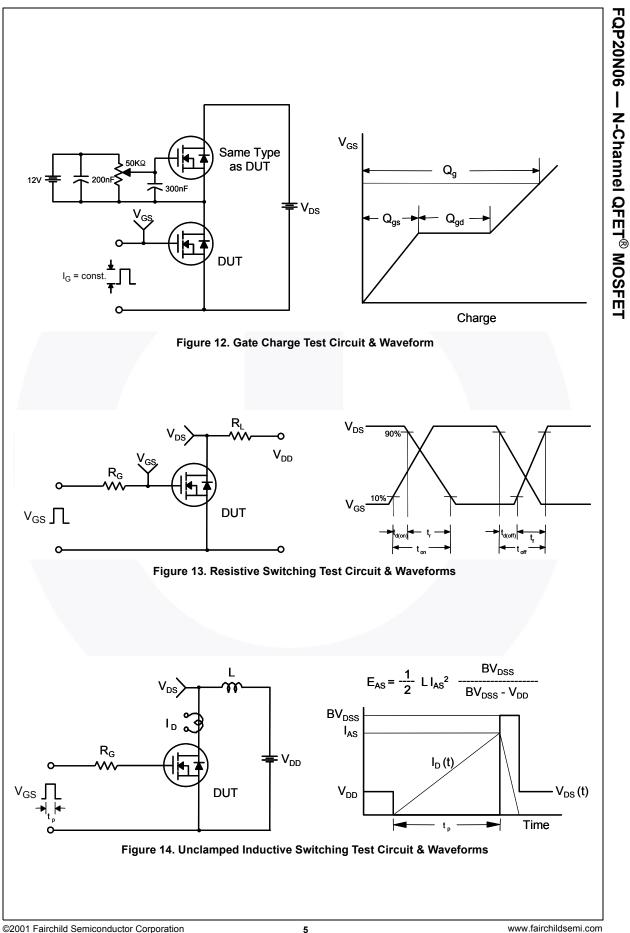


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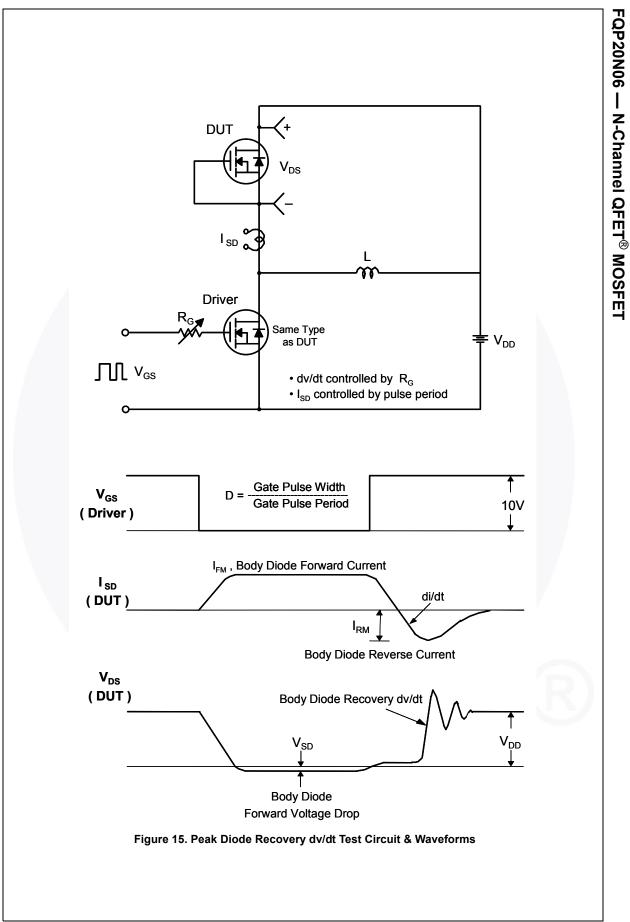


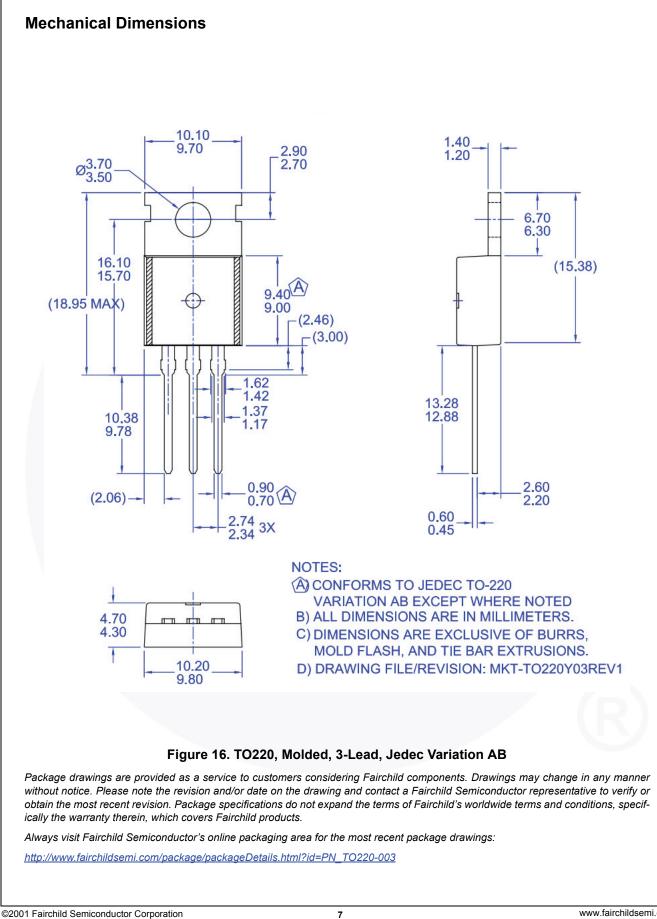
FQP20N06 Rev. C1

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